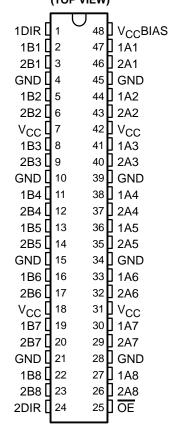
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- **Members of the Texas Instruments** Widebus™ Family
- Support the VME64 ETL Specification
- Reduced, TTL-Compatible, Input Threshold Range
- High-Drive Outputs ( $I_{OH} = -60 \text{ mA}$ ,  $I_{OL}$  = 90 mA) Support 25- $\Omega$  Incident-Wave Switching
- **V<sub>CC</sub>BIAS** Pin Minimizes Signal Distortion **During Live Insertion**
- Internal Pullup Resistor on OE Keeps **Outputs in High-Impedance State During Power Up or Power Down**
- Distributed V<sub>CC</sub> and GND Pins Minimize **High-Speed Switching Noise**
- Equivalent 25- $\Omega$  Series Damping Resistor on B Port
- Bus Hold on Data Inputs Eliminates the **Need for External Pullup/Pulldown** Resistors

## description

The 'ABTE16245 devices are 16-bit (dual-octal) noninverting 3-state transceivers designed for synchronous two-way communication between data buses. The control-function implementation minimizes external timing requirements. These devices can be used as two 8-bit transceivers or

SN54ABTE16245 . . . WD PACKAGE SN74ABTE16245 . . . DGG OR DL PACKAGE (TOP VIEW)



one 16-bit transceiver. They allow data transmission from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input. The output-enable (OE) input can be used to disable the device so that the buses are effectively isolated. When  $\overline{OE}$  is low, the device is active.

The B port has an equivalent 25- $\Omega$  series output resistor to reduce ringing. Active bus-hold inputs also are on the B port to hold unused or floating inputs at a valid logic level.

The A port provides for the precharging of the outputs via  $V_{CC}$ BIAS, which establishes a voltage between 1.3 V and 1.7 V when V<sub>CC</sub> is not connected.

Active bus-hold circuitry holds unused or undriven inputs at a valid logic state. Use of pullup or pulldown resistors with the bus-hold circuitry is not recommended.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

Widebus is a trademark of Texas Instruments



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### **ORDERING INFORMATION**

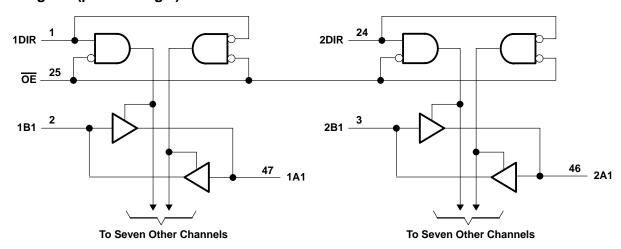
TA	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING
	SSOP – DL	Tube	SN74ABTE16245DL	ABTE16245
–40°C to 85°C		Tape and reel	SN74ABTE16245DLR	ADTE 10245
	TSSOP – DGG	Tape and reel	SN74ABTE16245DGGR	ABTE16245
–55°C to 125°C	CFP – WD	Tube	SNJ54ABTE16245WD	SNJ54ABTE16245WD

<sup>†</sup> Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

### **FUNCTION TABLE** (each 8-bit section)

INP	UTS	ODED ATION
OE	DIR	OPERATION
L	L	A data to B bus
L	Н	B data to A bus
Н	X	Isolation

## logic diagram (positive logic)



# absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage range, V <sub>CC</sub> and V <sub>CC</sub> BIAS	0.5 V to 7 V
Input voltage range, V <sub>I</sub> (except I/O ports) (see Note 1)	0.5 V to 7 V
Voltage range applied to any output in the high state or power-off state, VO	–0.5 V to 5.5 V
Current into any output in the low state, I <sub>O</sub>	128 mA
Input clamp current, I <sub>IK</sub> (V <sub>I</sub> < 0)	–18 mA
Output clamp current, I <sub>OK</sub> (V <sub>O</sub> < 0)	–50 mA
Package thermal impedance, θ <sub>JA</sub> (see Note 2): DGG package	70°C/W
DL package	63°C/W
Storage temperature range, T <sub>stq</sub>	–65°C to 150°C

<sup>‡</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
  - 2. The package thermal impedance is calculated in accordance with JESD 51-7.



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# recommended operating conditions (see Note 3)

					6245	SN74	ABTE16	3245	UNIT
			MIN	NOM	MAX	MIN	NOM	MAX	UNIT
V <sub>CC</sub> , V <sub>CC</sub> BIAS	Supply voltage		4.5	5	5.5	4.5	5	5.5	V
V	High-level input voltage	ŌĒ	2			2			V
VIH	riigii-ievei iriput voitage	Except OE	1.6			1.6			V
V.,	Low-level input voltage	ŌĒ			0.8			0.8	V
VIL	Low-level input voltage	Except OE			1.4			1.4	V
V <sub>I</sub>	Input voltage		0		VCC	0		VCC	V
lou	High lovel output ourrent	B bus			-12			-12	mA
ЮН	High-level output current	A bus			-24			-60	ША
la.	Love lovel output ourrent	B bus			12			12	A
lOL	Low-level output current	A bus			64			90	mA
Δt/Δν	Input transition rise or fall rate	Outputs enabled			10			10	ns/V
T <sub>A</sub>	Operating free-air temperature		-55		125	-40		85	°C

NOTE 3: All unused control inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

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## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	DAMETED	TEST OF	NDITIONS	SN	54ABTE1	6245	SN	74ABTE	16245	UNIT
PAR	RAMETER	1551 CC	ONDITIONS	MIN	TYP <sup>†</sup>	MAX	MIN	TYP <sup>†</sup>	MAX	UNII
VIK		$V_{CC} = 4.5 \text{ V},$	I <sub>I</sub> = -18 mA			-1.2			-1.2	V
		$V_{CC} = 5.5 \text{ V},$	I <sub>OH</sub> = -100 μA			V <sub>CC</sub> -0.2			V <sub>CC</sub> -0.2	
	B port	V <sub>CC</sub> = 4.5 V	$I_{OH} = -1 \text{ mA}$	2.4			2.4			
Vон		vCC = 4.5 v	$I_{OH} = -12 \text{ mA}$	2			2			V
VOH		$V_{CC} = 5.5 \text{ V},$	$I_{OH} = -1 \text{ mA}$			4.5			4.5	V
	A port	V <sub>CC</sub> = 4.5 V	$I_{OH} = -32 \text{ mA}$	2.4			2.4			
		VCC = 4.5 V	I <sub>OH</sub> = -64 mA				2			
	B port	V <sub>CC</sub> = 4.5 V	I <sub>OL</sub> = 1 mA			0.4			0.4	
VOL	Броп	VCC = 4.5 V	I <sub>OL</sub> = 12 mA						0.8	V
VOL	A port	V <sub>CC</sub> = 4.5 V	I <sub>OL</sub> = 64 mA			0.55			0.55	V
	A port	vCC = 4.5 v	I <sub>OL</sub> = 90 mA						0.9	
		V <sub>CC</sub> = 4.5 V	V <sub>I</sub> = 0.8 V	100			100			
I <sub>I</sub> (hold)	I <sub>I(hold)</sub> B port	VCC = 4.5 V	V <sub>I</sub> = 2 V	-100			-100			μΑ
		$V_{CC} = 5.5 \text{ V},$	$V_{I} = 0 \text{ to } 5.5 \text{ V}$			±500			±500	
1.	Control inputs	V <sub>CC</sub> = 5.5 V,	V <sub>I</sub> = V <sub>CC</sub> or GND			±1			±1	μA
tı	A or B ports	vCC = 5.5 v,	AL = ACC OLGIAD			±20			±20	μΑ
lozh <sup>‡</sup>	A port	$V_{CC} = 5.5 \text{ V},$	V <sub>O</sub> = 2.7 V			10			10	μΑ
lozL <sup>‡</sup>	A port	$V_{CC} = 5.5 \text{ V},$	V <sub>O</sub> = 0.5 V			-10			-10	μΑ
lo.	A port	V <sub>CC</sub> = 5.5 V,	V <sub>O</sub> = 2.5 V	-50	-120	-180	-50		-180	mA
Ю	B port	vCC = 5.5 v,	VO = 2.5 V	-25	<b>-</b> 52	-90	-25		-90	IIIA
l <sub>off</sub>		$V_{CC} = 0$ , $V_{I}$ or $V_{O} \le$	4.5 V, V <sub>CC</sub> BIAS = 0			±100			±100	μΑ
			Outputs high		28	36		28	36	
Icc	A or B ports	$V_{CC} = 5.5 \text{ V}, I_{O} = 0,$ $V_{I} = V_{CC} \text{ or GND}$	Outputs low		38	48		38	48	mA
		11-100000000	Outputs disabled		20	32		20	32	
loop	A or B ports	V <sub>CC</sub> = 5 V,	OE high		0.02			0.02		mA/
ICCD	A OI B POILS	C <sub>L</sub> = 50 pF	OE low		0.33			0.33		MHz
C <sub>i</sub>	Control inputs	V <sub>I</sub> = 2.5 V or 0.5 V				10		2.5	4	pF
C <sub>io</sub>	I/O ports	$V_0 = 2.5 \text{ V or } 0.5 \text{ V}$				13		4.5	8	pF

<sup>†</sup> All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C. ‡ The parameters I<sub>OZH</sub> and I<sub>OZL</sub> include the input leakage current.

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## live-insertion specifications over recommended operating free-air temperature range

DADA	METER		SN54	ABTE16	6245	SN74ABTE16245			UNIT		
PARAMETER TEST CONDITION					MIN	TYP <sup>†</sup>	MAX	MIN	TYP <sup>†</sup>	MAX	UNIT
loo (Va	a PIAC)	$V_{CC} = 0 \text{ to } 4.5$ $I_{O(DC)} = 0$	V, V <sub>CC</sub> BIAS = 4.5 V to 5.5		250	700		250	700		
ICC (VC	:Сыко)	$V_{CC} = 4.5 \text{ V to}$ $I_{O(DC)} = 0$	5.5 V <sup>‡</sup> , V <sub>CC</sub> BIAS = 4.5 V t			20			20	μΑ	
Va	A nort	VCC = 0	V <sub>CC</sub> BIAS = 4.5 V to 5.5 V	/	1.1	1.5	1.9	1.1	1.5	1.9	V
Vo	A port	ACC = 0	V <sub>CC</sub> BIAS = 4.75 V to 5.25 V		1.3	1.5	1.7	1.3	1.5	1.7	V
la	A port Ven - 0		VCCBIAS = 4.5 V	V <sub>O</sub> = 0	-20		-100	-20		-100	μΑ
10	A port	VCC = 0,	V (ССЫАЗ = 4.5 V	V <sub>O</sub> = 3 V	20		100	20		100	μΑ

<sup>†</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .

# switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_L$ = 50 pF (unless otherwise noted) (see Figure 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	۷ <sub>0</sub> ۲٫	V <sub>CC</sub> = 5 V, T <sub>A</sub> = 25°C			SN54ABTE16245		SN74ABTE16245	
	(1141 01)	(0011 01)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	
<sup>t</sup> PLH	Α	В	1.5	3.3	4.2	1.5	5.4	1.5	5.2	ns
<sup>t</sup> PHL	A	Ь	1.5	3.8	4.6	1.5	5.4	1.5	5.2	115
<sup>t</sup> PLH	В	۸	1.5	3	3.8	1.5	4.7	1.5	4.5	no
<sup>t</sup> PHL	Ь	Α	1.5	3.1	4	1.5	4.7	1.5	4.5	ns
<sup>t</sup> PZH	ŌĒ	^	2	3.9	5.3	2	6.4	2	6.2	ns
tpZL	OE .	Α	2	4.4	5.9	2	7	2	6.8	115
<sup>t</sup> PZH	<del></del>	В	2	4.5	6	2	7.3	2	7.1	
tPZL	ŌĒ	В	2	5	6.4	2	7.5	2	7.3	ns
<sup>t</sup> PHZ	ŌĒ	Δ.	2	4.9	5.9	2	7	2	6.7	
<sup>t</sup> PLZ	] OE	A	2	3.7	4.6	2	5.4	2	5.1	ns
<sup>t</sup> PHZ	ŌĒ	В	2	5.2	6.2	2	7.2	2	7	no
<sup>t</sup> PLZ	]		2	4	5	2	5.8	2	5.5	ns



<sup>‡</sup> VCC - 0.5 V < VCCBIAS

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# extended switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_L = 50$ pF (unless otherwise noted) (see Figure 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD	V(	V <sub>CC</sub> = 5 V, T <sub>A</sub> = 25°C			SN54ABTE16245		SN74ABTE16245		
	(IIVI O1)	(0011 01)		MIN	TYP	MAX	MIN	MAX	MIN	MAX		
t <sub>PLH</sub>	В	А	By = 12.0	1.5	3.2	4	1.5	5	1.5	4.8	ns	
t <sub>PHL</sub>	Б	A .	Rχ = 13 Ω	1.5	3.8	4.7	1.5	5.8	1.5	5.6	115	
tpLH	В	А	By - 26 O	1.5	3.1	4	1.5	4.8	1.5	4.6	200	
tpHL	ь	A	$R\chi = 26 \Omega$	1.5	3.5	4.4	1.5	5.2	1.5	4.9	ns	
<sup>t</sup> PLH	В	А	Dv. FC.O	1.5	3	3.8	1.5	4.7	1.5	4.5		
tPHL	Б	A	$R\chi = 56 \Omega$	1.5	3.3	4.2	1.5	5.1	1.5	4.7	ns	
	В	А	R <sub>X</sub> = Open		0.1	0.6		2		2		
t <sub>sk(p)</sub>	А	В	R <sub>X</sub> = Open		0.4	0.8		2		2	ns	
,	В	Α	$R_X = 26 \Omega$		0.3	0.8		2		2		
	В	Α	R <sub>X</sub> = Open		0.3	0.7		1.3		1.3		
t <sub>sk(o)</sub>	Α	В	R <sub>X</sub> = Open		0.7	1.1		1.3		1.3	ns	
( )	В	Α	$R_X = 26 \Omega$		0.5	1		1.3		1.3		
tt†	В	Α	$R_X = 26 \Omega$	0.5	0.8	1.5	0.5	1.5	0.5	1.5	ns	
t <sub>t</sub> ‡	А	В	R <sub>X</sub> = Open	3.5	5.5	7.3	3.5	8.1	3.5	7.9	ns	

<sup>†</sup> t<sub>t</sub> is measured between 1 V and 2 V of the output waveform.

# extended output characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_L = 50$ pF (see Figures 1 and 2)

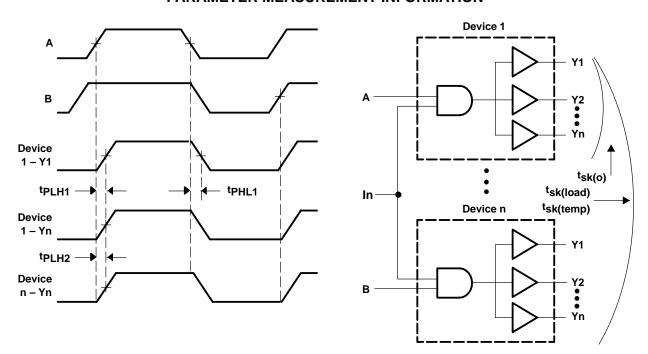
PARAMETER	ETER FROM TO TEST CONDITIONS		TEST CONDITIONS	LOAD	SN54ABTE16245		SN74ABTE16245		UNIT
PARAMETER			LOAD	MIN	MAX	MIN	MAX	UNIT	
4	Α	В	V <sub>CC</sub> = constant,			3		2.5	
<sup>t</sup> sk(temp)	В	Α	$\Delta T_A = 20^{\circ}C$	$R\chi = 56 \Omega$		4.5		4	ns
<sup>t</sup> sk(load)	В	В	V <sub>CC</sub> = constant, Temperature = constant	$R_X = 13, 26,$ or $56 \Omega$		4.5		4	ns



<sup>‡</sup>tt is measured between 10% and 90% of the output waveform.

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### PARAMETER MEASUREMENT INFORMATION

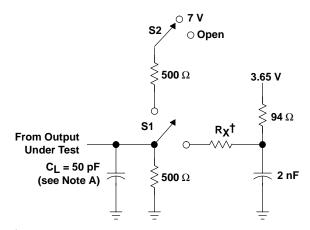


- NOTES: A. Pulse skew,  $t_{sk(p)}$ , is defined as the difference in propagation-delay times  $t_{PLH1}$  and  $t_{PHL1}$  on the same terminal at identical operating conditions.
  - B. Output skew, t<sub>Sk(0)</sub>, is defined as the difference in propagation delay of any two outputs of the same device switching in the same direction (e.g., |t<sub>PLH1</sub> t<sub>PLH2</sub>|).
  - C. Temperature skew,  $t_{sk(temp)}$ , is the output skew of two devices, both having the same value of  $V_{CC} \pm 1\%$  and with package temperature differences of 20°C.
  - D. Load skew,  $t_{sk(load)}$ , is measured with R<sub>X</sub> in Figure 2 at 13  $\Omega$  for one unit and 56  $\Omega$  for the other unit.

Figure 1. Voltage Waveforms for Extended Characteristics

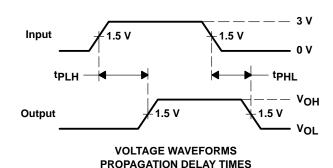
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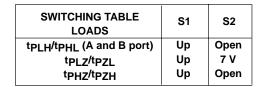
### PARAMETER MEASUREMENT INFORMATION



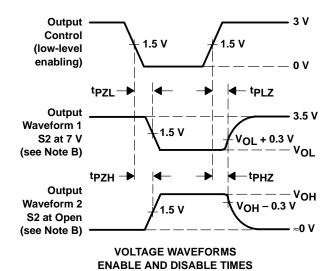
 $\dagger R_{X} = 13, 26, \text{ or } 56 \Omega$ 

### LOAD CIRCUIT FOR OUTPUTS





EXTENDED		
SWITCHING TABLE	S1	S2
LOADS		
tpLH/tpHL/t <sub>Sk</sub> (A port)	Down	Х
tpLH/tpHL/t <sub>sk</sub> (B port)	Up	Open
t <sub>t</sub> (A port) (see Note E)	Down	Х
t <sub>t</sub> (B port) (see Note F)	Up	Open



NOTES: A.  $C_L$  includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_O = 50 \Omega$ ,  $t_f \leq$  2.5 ns,  $t_f \leq$  2.5 ns.
- D. The outputs are measured one at a time with one transition per measurement.
- E. t<sub>t</sub> is measured between 1 V and 2 V of the output waveform.
- F. t<sub>t</sub> is measured between 10% and 90% of the output waveform.

Figure 2. Load Circuit and Voltage Waveforms







i.com 28-Feb-2005

### **PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
5962-9677501QXA	ACTIVE	CFP	WD	48	1	None	Call TI	Level-NC-NC-NC
SN74ABTE16245DGGR	ACTIVE	TSSOP	DGG	48	2000	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM
SN74ABTE16245DL	ACTIVE	SSOP	DL	48	25	None	CU NIPDAU	Level-1-235C-UNLIM
SN74ABTE16245DLR	ACTIVE	SSOP	DL	48	1000	None	CU NIPDAU	Level-1-235C-UNLIM
SNJ54ABTE16245WD	ACTIVE	CFP	WD	48	1	None	Call TI	Level-NC-NC-NC

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - May not be currently available - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

None: Not yet available Lead (Pb-Free).

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Green (RoHS & no Sb/Br): TI defines "Green" to mean "Pb-Free" and in addition, uses package materials that do not contain halogens, including bromine (Br) or antimony (Sb) above 0.1% of total product weight.

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDECindustry standard classifications, and peak solder temperature.

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